

TPC-DCS170W

17.0" SXGA Whiskey Lake Pcap. Panel PC

Version: 3.0



Features

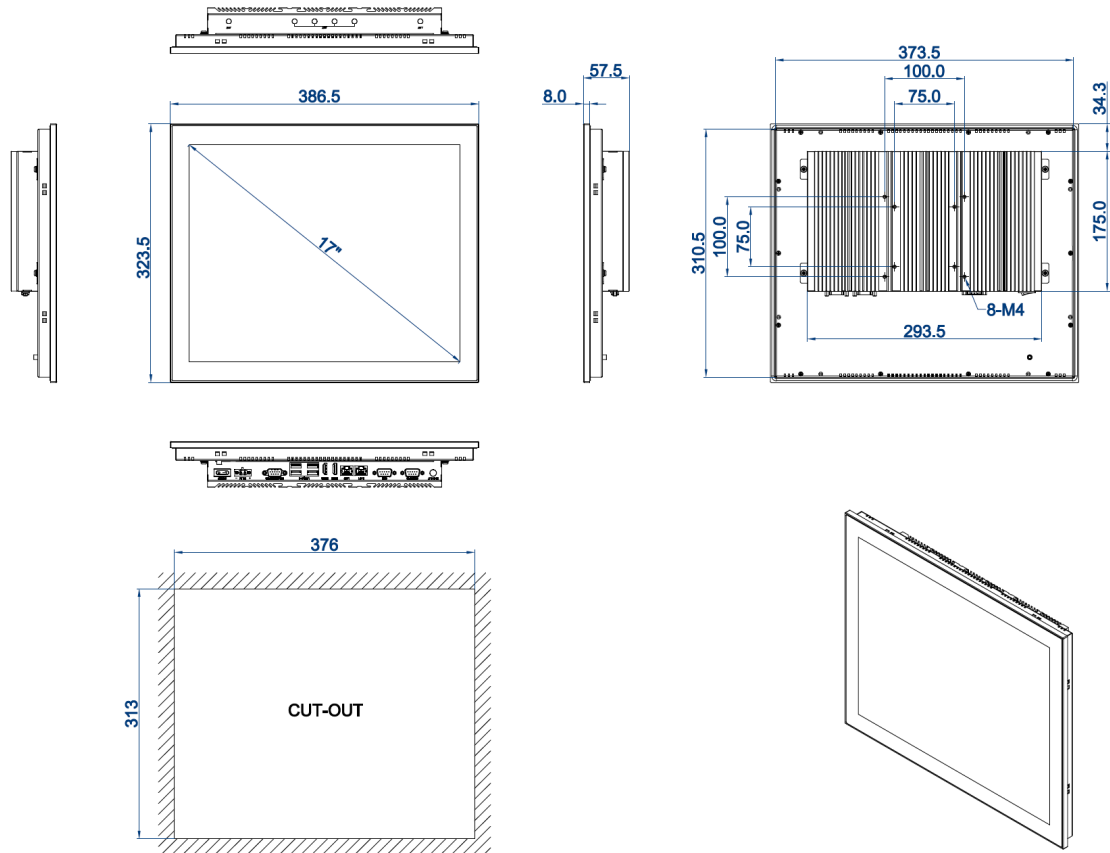
- 17.0" TFT LCD display, 4:3, LED Backlit, SXGA 1280 *1024;
- Intel 8th -gen. Whiskey Lake Celeron, Core i3/i5/i7 processor;
- Multi-points (Max. up to 10 points) Projective capacitive touch, EETI controller;
- Aluminum-magnesium alloy, anodized treatment, Modular designed;
- DC 12V, optional wide voltage DC 9~36V power input;
- IO: 2*GLAN, 4*USB3.0, 3*COM (DB9), 2*HDMI;
- Intel PTT TPM2.0, Support Windows 11 OS;
- Fan-less & Slim design, Panel mount, VESA, Front IP65 protection.

Specification

Hardware & System	BIOS	SPI AMI EEI BIOS
	CPU	Intel 8 th -gen. Whiskey Lake Celeron 4205U, Core i3-8145U, Core i5-8265U, Core i7-8565U
	Memory	SO-DIMM, DDR4-1866/2133/2400 MT/s, Max. up to 16GB
	Storage	1* M.2 NGFF Key-M/B slot + 1* 2.5" SATA
	Graphic	Intel UHD Graphics 620
	Network	1* Intel I211AT, and 1* Intel I219V LAN chips (Optional wireless 3G/4G, 5G, Wi-Fi/BT, Wi-Fi 6)
	Audio	On-board Realtek ACL 662 audio controller
	Expansion	1* M.2 Key-B slot, 1* M.2 Key-E slot
	Watch dog	0~256 seconds programmable
	OS	Win10, Win11, Linux, Ubuntu
IO interface	COM	3*RS232 (Default), Optional 1* RS485 or 8*GPIO
	Ethernet	2* RJ45, 10/100/1000 Mbps
	Audio	Optional Line-out
	USB	4x USB3.0
	Display	2x HDMI
	Power	1x 2 pins, phenix terminal
LCD Display	Size/Type	17.0" TFT LCD
	Resolution	1280 * 1024 (SXGA)
	Brightness	250 nits
	Backlit & MTBF	LED backlit & 30 000hours
	Display area	337.92 * 270.34
	View angle	85/85/85/85
Touchscreen	Type	Projective capacitive touchscreen
	Touch points	Multi points touch, max. up to 10 points
	Durability	>100 000 000 times
	Surface hardness	Mohs 6H
	Special treatment	Anti-fingerprint (AF)
Structure	Structure and surface	Magnesium-Aluminum alloy, sand blasting, anodized treatment
	Mount method	Panel mount, VESA 75/100
	Cooling system	Large area finned heat sink
	Overall dimension	386.5 * 323.5 * 57.5 (mm)
	Cut-out dimension	376 * 313 (mm)
	Net weight	4.7 KG
	IP protection	Front Panel IP65
Power & Environmental	Operating temp.	0 ~ +50°C
	Storage temp.	-20 ~ +60°C
	Relative Humidity	10 ~ 95% @ 10C (Non-condensation)
	Vibration	50 ~ 500 Hz, 1.5G, 0.15mm peak to peak
	Shock	10G/Peak (11 ms)
	Power input	DC 12V (Optional DC 9~36V)
	Power consumption	Around 40W
	EMC	CE/FCC Class A

DIMENSIONAL DRAWING:TPC-DCS170

Dimension



DIMENSIONS IN MILLIMETERS

TAICENN
 DATE:2022.01.27
 REV:A Unit:mm

Ordering info.

Part no.	Description
TPC-DCS170W0	17.0", 1280 * 1024, Celeron 4205U, Dual-core 1.8Ghz , Pcap. touch, 2*GLAN, 4*USB3.0, 3*COM, 2*HDMI, DC 12V, PSU
TPC-DCS170W1	17.0", 1280 * 1024, Core i3-8145U, Dual-core 2.1Ghz , Pcap. touch, 2*GLAN, 4*USB3.0, 3*COM, 2*HDMI, DC 12V, PSU
TPC-DCS170W2	17.0", 1280 * 1024, Core i5-8265U, Quad-core 1.6Ghz , Pcap. touch, 2*GLAN, 4*USB3.0, 3*COM, 2*HDMI, DC 12V, PSU
TPC-DCS170W3	17.0", 1280 * 1024, Core i7-8565U, Quad-core 1.8Ghz , Pcap. touch, 2*GLAN, 4*USB3.0, 3*COM, 2*HDMI, DC 12V, PSU
Memory	SO-DIMM, DDR4,4GB/8GB/16GB Memory
Storage	M.2 SSD: 128GB/256GB/512GB
	2.5" SATA SSD: 64GB/128GB/256GB/512GB/1TB
	2.5" HDD: 2TB/4TB
Wireless Modules	Wi-Fi module, with Antenna (M.2 interface)
	Wi-Fi with BT integrated module, with Antenna (M.2 interface)
	All network 4G/LTE module, With Antenna (M.2 interface)
	5G module, with Antenna (M.2 interface)
DC modules	DC to DC, wide voltage DC 9~36V
SIM Card module	Sim card slot for 3G/4G/5G Wireless function

Packing List

- 1x Standard Product
- 1x 60W PSU (Power Supply)
- 1x Power cable & Plug
- 8x Panel mount metal clips